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|--------------------------|---|
| Product Status | Production |
| Applications | Automotive Grade |
| Feature | AEC-Q200AEC-Q200 |
| | MultilayerMultilayer |
| | Non-Mag CoreNon-Magnetic Core (Dielectric Ceramic) |
| | High QHigh Q |
| Series Type | MLG-P |
| Brand | TDK |
| Environmental Compliance | <div><div>RoHS</div><div>REACH</div><div>Halogen Free</div><div>Lead Free</div></div> |



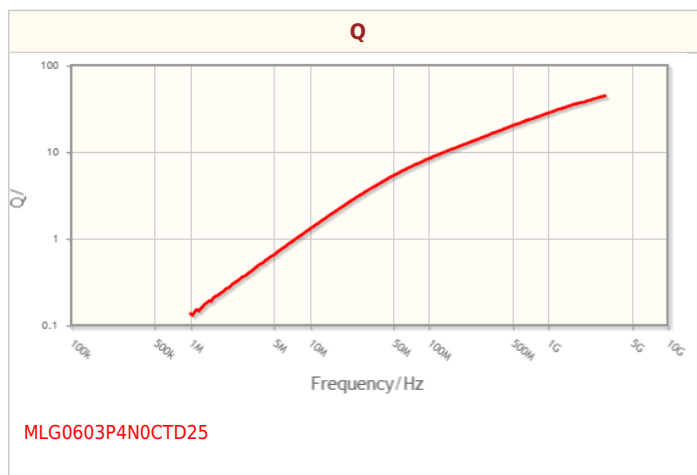
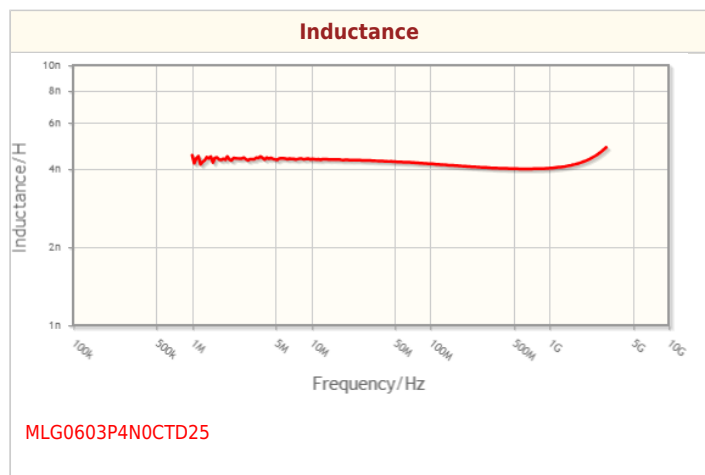
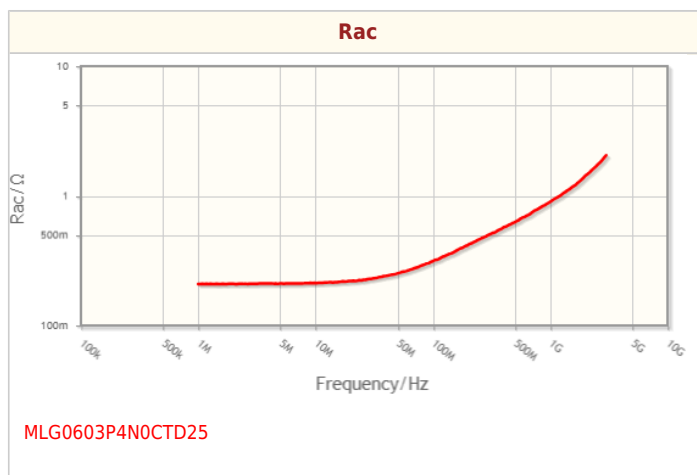
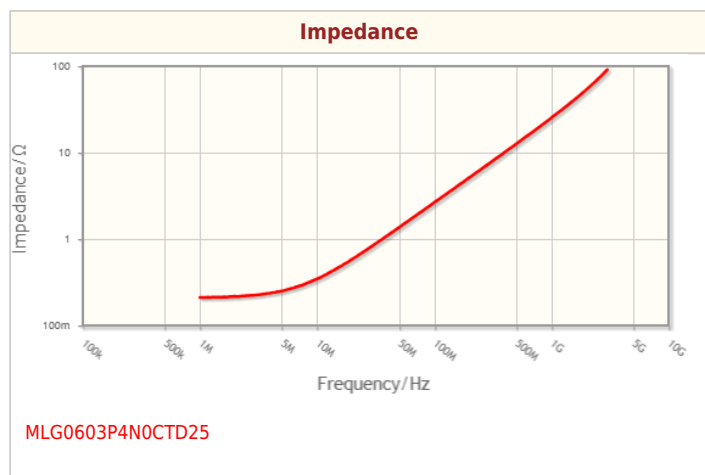
| Size | |
|------------------------------|----------------|
| Length(L) | 0.60mm ±0.03mm |
| Width(W) | 0.30mm ±0.03mm |
| Thickness Height | 0.30mm ±0.03mm |
| Recommended Land Pattern (A) | 0.25mm Nom. |
| Recommended Land Pattern (B) | 0.30mm Nom. |
| Recommended Land Pattern (C) | 0.30mm Nom. |

| Electrical Characteristics | |
|--------------------------------|----------------------|
| Inductance | 4nH ±0.2nH at 500MHz |
| Rated Current | 350mA |
| DC Resistance [Typ.] | 210mΩ |
| DC Resistance [Max.] | 400mΩ |
| Self Resonant Frequency [Min.] | 5.8GHz |
| Self Resonant Frequency [Typ.] | 6.7GHz |
| Q [Min.] | 14 at 500MHz |
| Q [Typ.] | 18 at 500MHz |

| Other | |
|-----------------------|--|
| Operating Temp. Range | -55 to 125°C |
| Soldering Method | Reflow |
| AEC-Q200 | YES |
| Packing | Punched (Paper)Taping [180mm Reel, Tape width 8mm] |
| Package Quantity | 15000pcs |
| Weight | 0.0002g |

! Images are for reference only and show exemplary products.
! This PDF document was created based on the data listed on the TDK Corporation website.
! All specifications are subject to change without notice.

Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)



Associated Images

